(Rev. 03/01)	- radomark Office
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To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.	
Name of conveying party(ies):	Name and address of receiving party(ies)
1) Hong-Yi Wu	Name: Taiwan Semiconductor Manufacturing Co., Ltd.
Chih-Jung Weng Chung-Cheng Ni	Internal Address:
4) Yi-Hsin Yu	
Additional name(s) of conveying party(ies) attached? Yes V No	
3. Nature of conveyance:	
Assignment Merger	No 9 Li Heir Dood C
Security Agreement Change of Name	Street Address: No. 8, Li-Hsin Road 6,
Other	Science Based Industrial Park
	or Hein Chu
1) 10/14/03 2) 10/14/03 3) 10/13/03 Execution Date: 4) 10/14/03	City: Hsin-Chu State: Zip: Country: Taiwan 300-77, R.O.C.
	Additional name(s) & address(es) attached? Yes V
4. Application number(s) or patent number(s):	
	cation, the execution date of the application is:10/14/2003_
A. Patent Application No.(s) 10696300	B. Patent No.(s)
Additional numbers attached? Yes Vo	
Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name:William H. Murray, Esquire	7. Total fee (37 CFR 3.41)\$_\$40.00
Internal Address: Duane Morris LLP	✓ Enclosed
	Authorized to be charged to deposit account
	8. Deposit account number:
Street Address: One Liberty Place	·
City: Philadelphia State: PA Zip: 19103	
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9. Signature.	
0.1	1 11 200
William H. Murray Esquire	October 29, 2003
Name of Person Signing	Signature Date
Total number of pages including cover	sheet attachments and documents: 4

Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments Washington, D.C. 20231

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PATENT

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EXPRESS MAIL LABEL NO. EV 306256268 US

Attorney Docket No.: N1085-00189 [TSMC2003-0271]

ASSIGNMENT AND AGREEMENT

For value received, we, Hong-Yi Wu, Chih-Jung Weng, Chung-Cheng Ni, and Yi-Hsin Yu, hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to METHOD AND SYSTEM OF CONTROLLING DUMMY DISPENSE described in an application for Letters Patent of the United States and all the rights and privileges in said application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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REEL: 014654 FRAME: 0071

EXPRESS MAIL LABEL NO. EV 306256268 US

Attorney Docket No.: N1085-00189 [TSMC2003-0271]

We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1 Dated: 0.0.14, 2003	Hong Yi, Wu Hong Yi Wu
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Attorney Docket No.: N1085-00189

[TSMC2003-0271]

Inventor No. 4
Dated: >003/10/14

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